

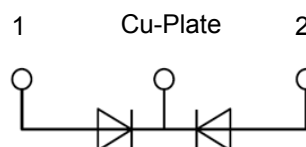
PRODUCT FEATURES

- Ultrafast Reverse Recovery Time
- Soft Reverse Recovery Characteristics
- Low Reverse Recovery Loss
- Low Forward Voltage
- High Surge Current Capability
- Low Leakage Current



APPLICATIONS

- Inversion Welder
- Uninterruptible Power Supply
- Plating Power Supply
- Ultrasonic Cleaner and Welder
- Converter & Chopper
- PFC



ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Values	Unit
V_R	Maximum D.C. Reverse Voltage		600	V
V_{RRM}	Maximum Repetitive Reverse Voltage			
$I_{F(AV)}$	Average Forward Current	$T_C=110^\circ\text{C}$, Per Diode	150	A
		$T_C=110^\circ\text{C}$, Per Mouldle	300	
$I_{F(RMS)}$	RMS Forward Current	$T_C=110^\circ\text{C}$, Per Diode	210	
I_{FSM}	Non Repetitive Surge Forward Current	$T_J=45^\circ\text{C}$, $t=10\text{ms}$, Sine, peak value	2500	
		$T_J=45^\circ\text{C}$, $t=8.3\text{ms}$, Sine, peak value	2750	
I^2t	For Fusing	$T_J=45^\circ\text{C}$, $t=10\text{ms}$, Sine, peak value	31250	A^2S
		$T_J=45^\circ\text{C}$, $t=8.3\text{ms}$, Sine, peak value	31380	
P_D	Power Dissipation		1560	W
T_J	Junction Temperature		-40 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-40 to +125	$^\circ\text{C}$
Torque	Module to Sink	Recommended (M6)	3~4.7	Nm
Torque	Module Electrodes	Recommended (M6)	3~4.7	Nm
R_{thJC}	Junction to Case Thermal Resistance(Per Diode)		0.08	$^\circ\text{C}/\text{W}$
Weight			92	g

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ELECTRICAL CHARACTERISTICS ($T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600\text{V}$		0.5	mA
		$V_R = 600\text{V}, T_J = 125^\circ\text{C}$		10	
V_F	Forward Voltage	$I_F = 150\text{A}$	1.2		V
		$I_F = 150\text{A}, T_J = 125^\circ\text{C}$	1.05		
t_{rr}	Reverse Recovery Time ($I_F = 1\text{A}, dI_F/dt = -200\text{A}/\mu\text{s}, V_R = 30\text{V}$)		54		ns
t_{rr}	Reverse Recovery Time		100		ns
I_{RRM}	Maximum Reverse Recovery Current		11		
t_{rr}	Reverse Recovery Time		200		ns
I_{RRM}	Maximum Reverse Recovery Current		20		

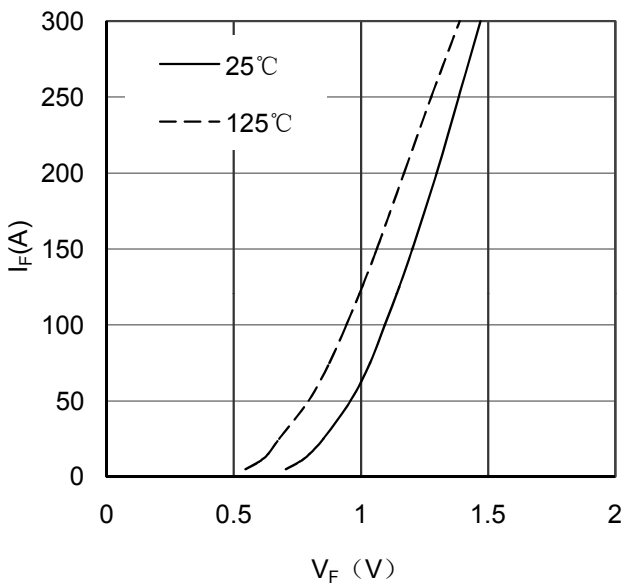


Figure 1. Forward Voltage Drop vs Forward Current

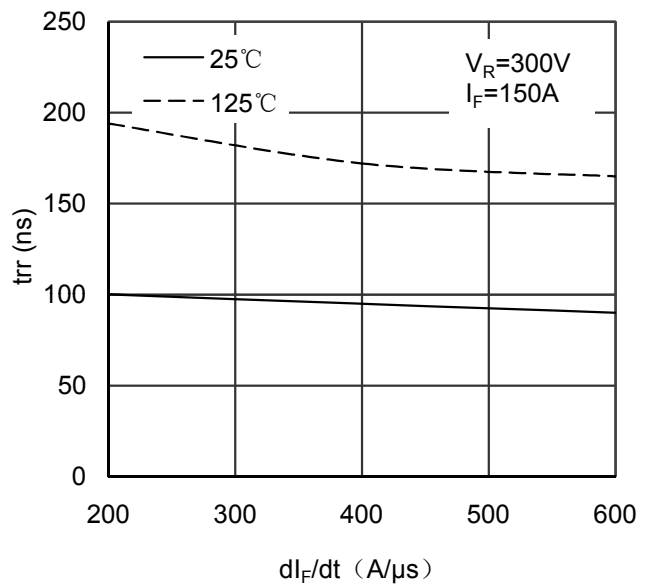


Figure 2. Reverse Recovery Time vs dI_F/dt

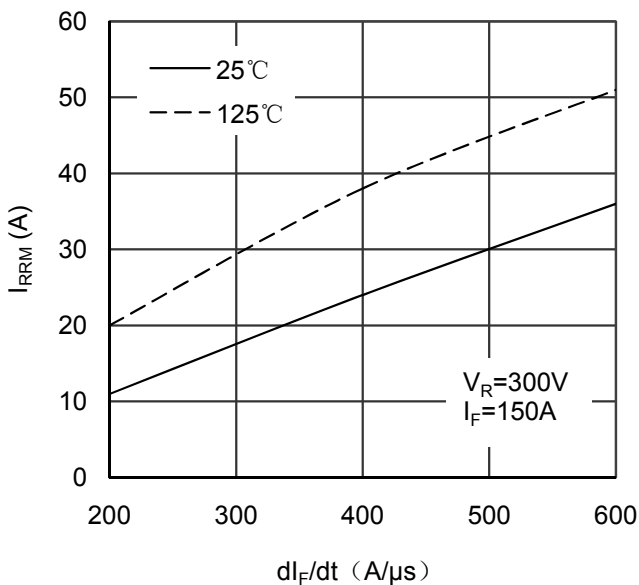


Figure 3. Reverse Recovery Current vs dI_F/dt

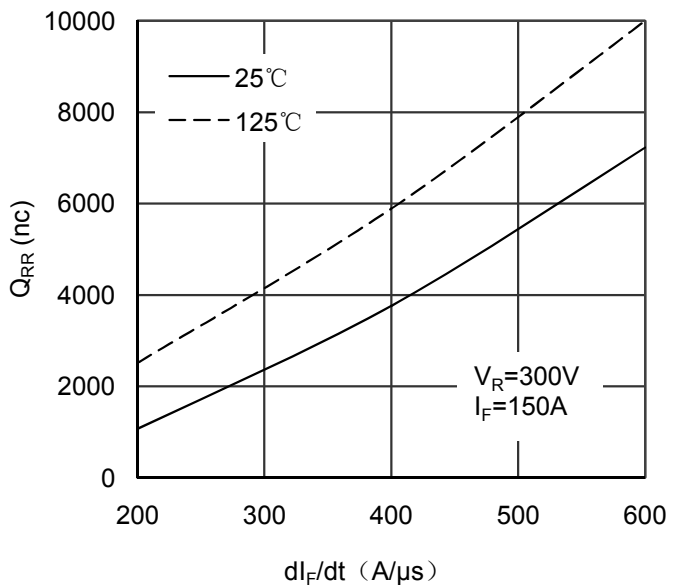


Figure 4. Reverse Recovery Charge vs dI_F/dt

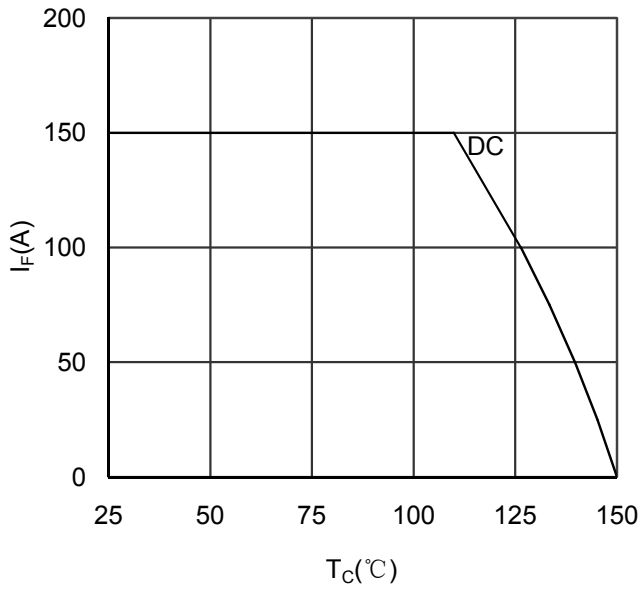


Figure 5. Forward current vs Case temperature

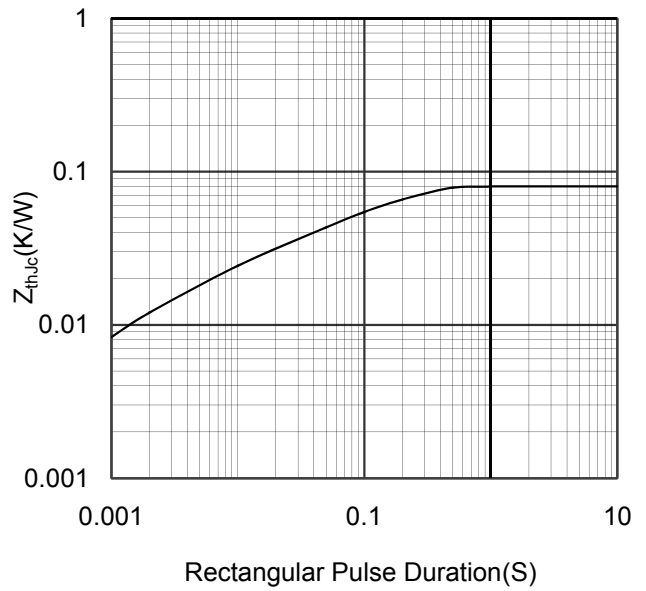
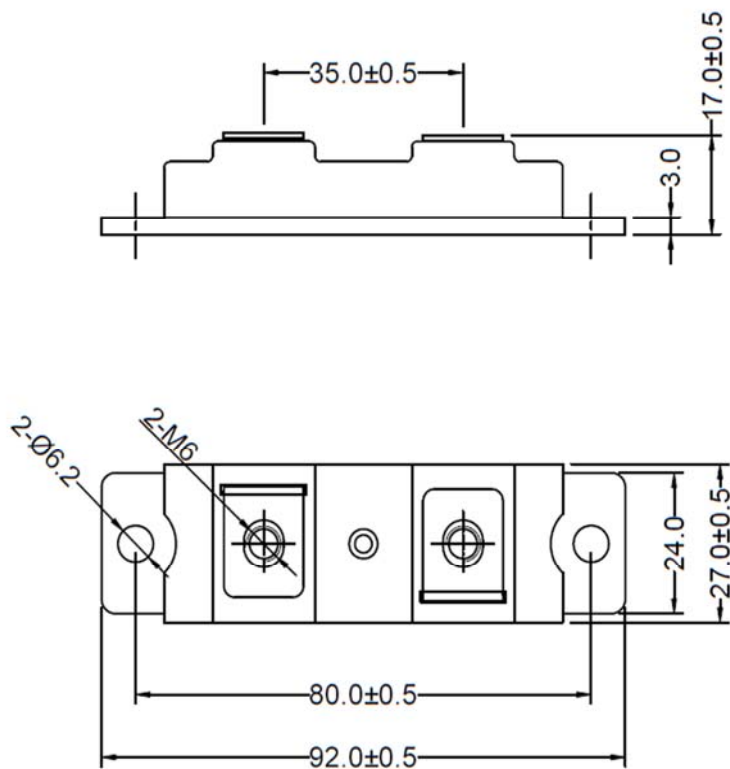


Figure 6. Transient Thermal Impedance



Dimensions in (mm)

Figure 7. Package Outline